

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Unit |
|---|-----------------|--|-----------------|--------------|------|
| Drain-Source Voltage | | | V_{DSS} | -20 | V |
| Gate-Source Voltage | | | V_{GSS} | ±10 | V |
| Continuous Drain Current (Note 6) V _{GS} = -4.5V | Steady State | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | I _D | -3.5 -2.8 | А |
| Continuous Drain Current (Note 6) $V_{GS} = -2.5V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$ | | ΙD | -3.0 -2.4 | Α | |
| Maximum Continuous Body Diode Forward Current (Note 6) | | | Is | -1.5 | А |
| Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%) | | | I _{DM} | -15 | A |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|--|--------------|----------------------------------|-------------|------|
| Total Power Dissipation (Note 5) | | P_D | 0.8 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $R_{\theta JA}$ | 158 | °C/W |
| Total Power Dissipation (Note 6) | | P _D | 1.2 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | $R_{\theta JA}$ | 100 | °C/W |
| Operating and Storage Temperature Range | • | T _{J,} T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

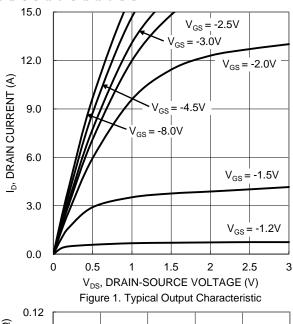
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-------|------|------|------|--|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -20 | _ | _ | V | $V_{GS} = 0V, I_D = -250\mu A$ | |
| Zero Gate Voltage Drain Current T _J = +25°C | I _{DSS} | _ | _ | -1.0 | μA | V _{DS} = -16V, V _{GS} = 0V | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 8V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | -0.45 | _ | -1.0 | V | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | |
| Chatia Dunia Carras On Basistanas | | | 55 | 80 | mΩ | V _{GS} = -4.5V, I _D = -2.8A | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | _ | 67 | 110 | | $V_{GS} = -2.5V, I_D = -2.0A$ | |
| Diode Forward Voltage | V_{SD} | | -0.7 | -1.0 | V | V _{GS} = 0V, I _S = -1A | |
| DYNAMIC CHARACTERISTICS (Note 8) | • | | | | | • | |
| Input Capacitance | C _{iss} | _ | 443 | _ | pF | | |
| Output Capacitance | Coss | _ | 59 | _ | pF | $V_{DS} = -10V, V_{GS} = 0V$ - f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | _ | 47 | _ | pF | T = 1.0IVIH2 | |
| Gate Resistance | R_{G} | | 8.5 | | Ω | $V_{GS} = 0V, V_{DS} = 0V, f = 1.0MHz$ | |
| Total Gate Charge | Qq | _ | 6.0 | _ | nC | V _{GS} = -4.5V, V _{DS} = -10V, I _D = -3A | |
| Gate-Source Charge | Q_{gs} | _ | 0.6 | _ | nC | | |
| Gate-Drain Charge | Q_{gd} | _ | 1.8 | _ | nC | | |
| Turn-On Delay Time | t _{D(ON)} | _ | 4.0 | _ | ns | | |
| Turn-On Rise Time | t _R | _ | 3.7 | _ | ns | $V_{DS} = -10V, V_{GS} = -4.5V,$ $R_{L} = 10\Omega, R_{G} = 1.0\Omega, I_{D} = -1A$ | |
| Turn-Off Delay Time | t _{D(OFF)} | | 24.5 | _ | ns | | |
| Turn-Off Fall Time | t _F | _ | 9.5 | _ | ns | | |
| Reverse Recovery Time | t _{RR} | | 8.3 | _ | ns | I _F = -1.0A, di/dt = 100A/μs | |
| Reverse Recovery Charge | Q_{RR} | | 2.0 | _ | nC | I _F = -1.0A, di/dt = 100A/µs | |

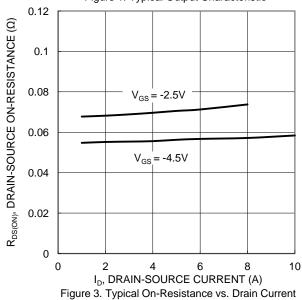
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

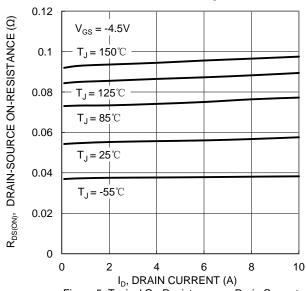
^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.

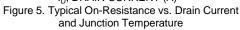


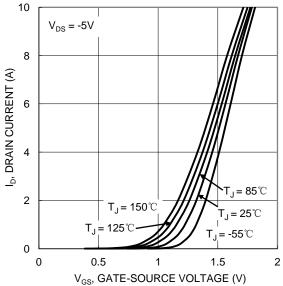




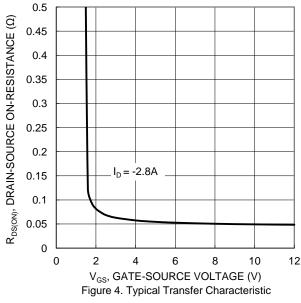


and Gate Voltage





 V_{GS} , GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic



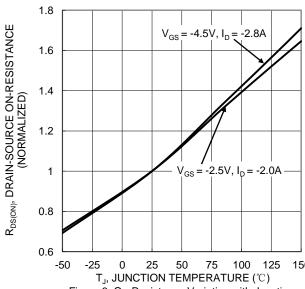
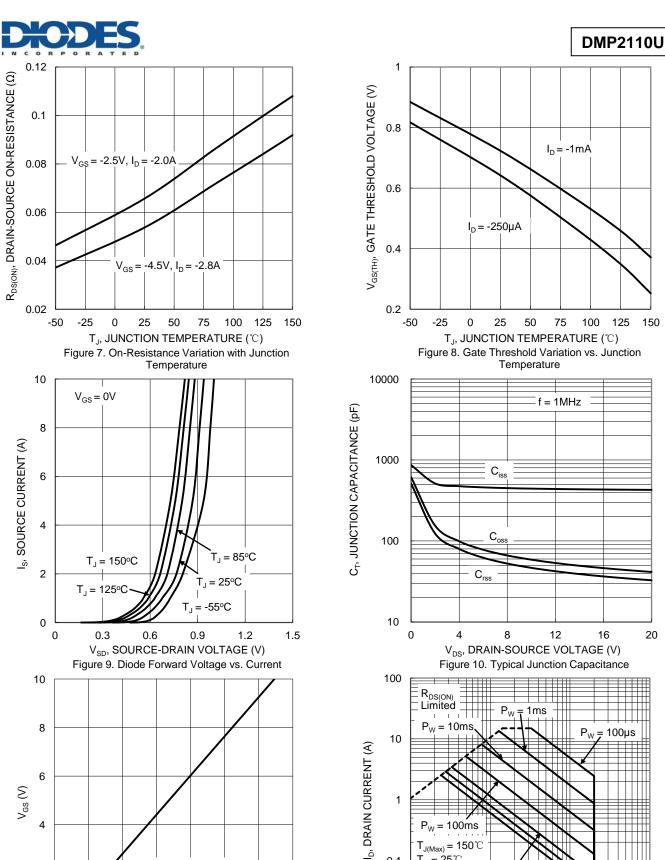


Figure 6. On-Resistance Variation with Junction Temperature



4

2

0 0

100

150

20



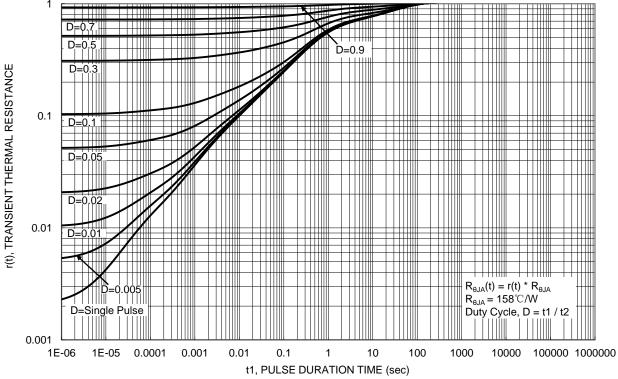


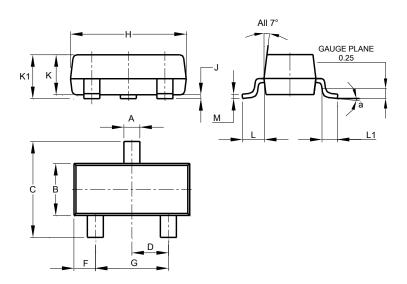
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

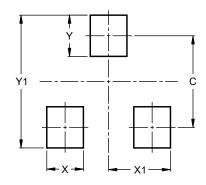


| SOT23 | | | | | |
|----------------------|-------|-------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.37 | 0.51 | 0.40 | | |
| В | 1.20 | 1.40 | 1.30 | | |
| С | 2.30 | 2.50 | 2.40 | | |
| D | 0.89 | 1.03 | 0.915 | | |
| F | 0.45 | 0.60 | 0.535 | | |
| G | 1.78 | 2.05 | 1.83 | | |
| Н | 2.80 | 3.00 | 2.90 | | |
| J | 0.013 | 0.10 | 0.05 | | |
| K | 0.890 | 1.00 | 0.975 | | |
| K1 | 0.903 | 1.10 | 1.025 | | |
| L | 0.45 | 0.61 | 0.55 | | |
| L1 | 0.25 | 0.55 | 0.40 | | |
| М | 0.085 | 0.150 | 0.110 | | |
| а | 0° | 8° | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 2.0 |
| Х | 0.8 |
| X1 | 1.35 |
| Y | 0.9 |
| Y1 | 2.0 |



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